16-Channel Integrated Potentiostat for Distributed Neurochemical Sensing

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Abstract—We present the architecture and VLSI circuit implementation of a BiCMOS potentiostat bank for monitoring neurotransmitter concentration on a screen-printed carbon electrode array. The potentiostat performs simultaneous acquisition of bidirectional reduction-oxidation currents proportional to neurotransmitter concentration on 16 independent channels at controlled redox potentials. Programmable current gain control yields over 100 dB cross-scale dynamic range with 46 pA input-referred RMS noise over 12kHz bandwidth. The cut-off frequency of a second order log-domain anti-aliasing filter ranges from 50 Hz to 400 kHz. Track-and-hold current integration is triggered at the sampling rate between DC and 200 kHz. A 2.25mm \times 2.25mm prototype was fabricated in a 1.2 \mu m VLSI technology and dissipates 12.5 mW. Chronoamperometry dopamine concentration measurements results are given. Other types of neurotransmitters can be selected by adjusting the redox potential on the electrodes and the surface properties of the sensor coating.

Index Terms—Potentiostat, biomedical instrumentation, neurotransmitters, dopamine sensor arrays, analog VLSI, current-mode circuits, log-domain signal processing

I. INTRODUCTION

Implantable integrated technologies that enable simultaneous monitoring of chemical neural activity at different locations in the brain could have far reaching impact in understanding the neurophysiology of sensory-motor systems, encoding in auditory nerve and visual cortex among others, and could lead to breakthroughs in areas such as neural prostheses, artificial tissue engineering, and automated neural disorders diagnostics and therapy. A number of integrated potentiostats suitable for on-chip voltammetry or amperometry have been recently reported. Single-channel implementations include [1]-[4]. For distributed electrochemical neural recording, we recently reported an 8-channel integrated potentiostat [5], [6] and a 16-channel integrated potentiostat [7], [8], [9]. The electrochemical current output from a neurochemical sensor is usually on the order of picoamperes, but can reach the microampere range during transients or catastrophic events such as stroke [10]. The potentiostat in [9] employs oversampling data conversion techniques to achieve the high dynamic range, from picoamperes to milliamperes over nine programmable scales of current, at the cost of reduced sampling rate of less than 30 samples per second for the smallest current scale.

In this work we present a 16-channel integrated potentiostat microsystem for simultaneous monitoring of chemical neural activity at different locations in the brain at sampling rates ranging from DC to 200ksps while maintaining over 100dB cross-scale dynamic range. Such sampling rate is important as the spectrum of electrochemical neural activity often remains significant at higher frequencies (i.e., up to 10kHz). A current-mode BiCMOS design yields high dynamic range in track-and-hold current acquisition [11]. The integrated potentiostat records bidirectional reduction-oxidation (redox) currents at controlled redox potentials from a 16-electrode array of screen-printed carbon-based chemical sensors [12]. The acquired currents are proportional to the concentration of neurotransmitter dopamine near the electrodes. Various types of neurotransmitters can be selected by adjusting the redox potential on the electrodes and the surface properties of the sensor coating [13], [14]. The rest of the paper is organized as follows. Section II presents the architecture of the 16-channel integrated potentiostat. Section III details its VLSI implementation. Section IV contains experimental results of in vitro neurotransmitter concentration measurements in real time.

II. ARCHITECTURE

To simultaneously transduce the neurotransmitter activity at multiple locations of brain tissue in close proximity to the neurochemical sensor array, a multi-channel potentiostat amplifier has been developed. Each channel of the integrated system simultaneously acquires the oxidation-reduction current generated at the surface of each electrode, amplifies it and converts it to a differential voltage.
The block diagram of one channel of the 16-channel integrated potentiostat is presented in Figure 1. Each channel is connected to one working electrode with the redox potential, the necessary voltage for driving the redox reactions, set by the voltage $V_{\text{red}}$ on its virtual 'ground' node. The channels are organized in groups of four with one independent redox voltage per group. An additional reference electrode, common for all working electrodes, is also placed in the bath. Each of the 16 data channels is independently programmed to have a current gain covering four orders of magnitude allowing to acquire bidirectional currents up to 50 $\mu$A, at a redox voltage ranging from 0 to 5V. An additional bias channel (not shown) supplies all bias and reference signals as well digital control signals. In each data channel, the bidirectional input redox current is summed with an appropriately scaled offset current $I_{\text{off}}$ in order to obtain a unidirectional current. The PMOS transistor in the negative feedback of the input transconductance amplifier conveys the current at the supplied redox voltage. The PMOS transistor has the well connected to the source to minimize the back-gate effect, as needed for a 5V range of the redox voltage.

The acquired input current is subsequently fed into the normalizing circuit. The circuit is programmed to normalize the unidirectional current to a fixed range of 1 $\mu$A. This range is chosen appropriately as a trade-off between signal-to-noise ratio and integration time constant further in the channel. The normalized current is fed into the anti-aliasing low-pass filter. The integrator at the end of the signal path includes a track-and-hold circuit. It provides a differential output voltage buffered in a pipelined fashion.

III. VLSI IMPLEMENTATION

A track-and-hold potentiostat integrated prototype was designed and fabricated in a 1.2 $\mu$m double-poly BiCMOS process, which includes a p-Base layer to implement vertical NPN bipolars. Vertical NPN and lateral PNP transistors are used in the design with the goal of improving device matching beyond that attainable with MOS transistors [15]. The chip micrograph is shown in Figure 2. The sections below focus on particular circuit design solutions and their experimentally measured performance.

A. Transconductance Amplifier

For accurate acquisition of small-amplitude currents, a transconductance amplifier depicted in Figure 3 is employed in the input current conveyor. It provides a low input impedance virtual node at a user-selectable redox voltage. The amplifier is a wide output range single stage differential amplifier with a PMOS input differential pair and cascoded BiCMOS current mirrors. The differential pair transistors are laid out in a centroid configuration to lower input offset voltage. Higher accuracy current replication is obtained by using current mirrors base current compensation with MOS source followers. The choice of 7V and -2V supply voltage rails allows the redox voltage to range from 0V to 5V (typical values for carbon-based sensors).

The measured input offset voltages are in the range between 5mV and 10mV (for single ended input), for the minimum and maximum input current scales respectively, with the input impedance of 125 $\Omega$. From our experience these offset figures are typical for the technology used, even for a centroid configuration, due to poor control of fabrication process parameters.
B. Current Normalization Circuit

The acquired input current of each data channel is normalized to a fixed range suitable for further processing. Normalization circuitry shown in Figure 4 performs this task. The programmable scaling selects between four input ranges of current, 100nA, 1µA, 10µA, and 100µA, independently for every data channel. This scaling function provides for a floating point representation and drastically increased dynamic range. While each channel is designed to provide at least 40dB dynamic range for any given current range, the cross-scale dynamic range representing the union of the dynamic ranges at all current scales exceeds 100dB. Channel gains are changed dynamically when an overflow is detected. The value of the input offset current $I_{off}$ is programmed on-chip simultaneously with programming the current gain of a channel. Thus dynamic re-programming of input current range is possible as no manual tuning of the offset current is required.

The four BiCMOS current mirrors can be configured to attenuate the input signal with a gain of 0.01, 0.1, 1 or 10 by switching bipolar transistors bases controlled by bits $b_0$ and $b_1$. Amplification of currents with gains other than one is performed using NPN vertical transistors, as the gain control by scaling of the emitter area is more precise and reproducible. The output current is a replica of the input current normalized to a range 0–1µA. Any nonlinear effects in the normalization, and in subsequent processing stages, can easily be accounted for by a lookup table type calibration in software.

C. Anti-Aliasing Filter

To allow aliasing-free sampling of the normalized currents, a second-order low-pass log-domain filter (LPF) [16], [17], [18] with a selectable cut-off frequency shown in Figure 5 is incorporated into the channel. Each stage constitutes a single pole linear time-invariant (LTI) system with unity DC gain if the bias currents are supplied as shown in Figure 5. Two single-stage log-domain filters are combined in such a way that the output common-base configuration NPN transistors of the first stage serve as the input transistor pair of the second stage. The cut-off frequency set by the current $I_{bias}$ can be programmed in the range from 50Hz to 400kHz [17].

The filter prevents aliasing and eliminates high-frequency noise and interference introduced prior to sampling, and additionally allows to bypass the subsequent current-mode sample-and-hold circuit, not shown, before the integration stage, by selecting a time constant sufficiently larger than the integration time interval. Figure 6 depicts measured channel current transfer characteristics for the largest and the smallest current scale for eight adjacent channels. As expected, channel matching improves at larger currents. The observed current spread is attributed to poor control of fabrication process parameters.

D. Integrator and Hold Buffer

Integration circuitry described in this section performs conversion of normalized currents into a differential voltage and produces a continuously available output signal.
As depicted in Figure 7 (a), the integration circuit is employed once in each, $j$-th, data channel, and separately twice in the bias channel.

Integration of the 0.5µA DC reference current in the bias channel generates the midpoint voltage, $V_{out-}$, used as a 'zero-level' of the output signal. The differential output format reduces sensitivity to noise and power supply variations. A 16-to-1 multiplexer selects the integrated signal of one of the 16 channels at the output.

Integration of the 1µA DC reference current by the second integrator in the bias channel determines the integration time of all 16 channels. This is achieved by generating the upper-bound voltage, $V_{int}$, with respect to analog ground AGND and comparing it with the analog supply voltage AVDD. Once the upper-bound voltage reaches AVDD, a control signal $INT$ is set as shown in Figure 7 (b), which completes integration in all channels (including the two bias channel integrators themselves). This corresponds to a 5µs integration time, or 200kHz maximum sustained sampling frequency.

The circuit diagram of a single integrator is given in Figure 8. It employs a single-ended nMOS common-source cascoded amplifier. The mirrored input current is integrated on the feedback capacitor of the amplifier. The external digital signal RST is a narrow pulse resetting the integrating capacitor on the rising edge, and also resetting the $INT$ signal on the falling edge. The signal $RSTd$ is a delayed version of RST. The input current is integrated while $INT$ is low.

In order to produce continuously available output voltage, the output voltage is sampled on a capacitor by the digital signal THRU and held while a subsequent current is integrated in a pipelined fashion. Figure 9 (a) depicts measured channel transfer characteristics (integ-
test was conducted in 25ml of degassed phosphate-buffered saline (PBS) solution (without Mg²⁺ or Ca²⁺) at a pH of 7.4. Standard chronoamperometry was employed to measure the current, in which the working carbon electrode was held at 900mV with respect to the Ag/AgCl reference electrode. The current was recorded as a function of time as shown in Figure 10. Con-trolled amounts of dopamine solution were introduced into degassed phosphate-buffered saline solution every four minutes and briefly stirred. The current spikes correspond to recordings during the manual stirring and are thus not relevant. The pedestals correspond to the steady state concentration measurements and are monotonically increasing, consistent with the amounts of dopamine added. The calibration curve of the sensor-chip system depicted in Figure 11 was obtained by calculating average currents for discrete concentration levels.

V. CONCLUSIONS

A 16-channel integrated potentiostat for simultaneous parallel recording of neurochemical activity has been interfaced with a 16-electrode array of carbon-coated neurotransmitter sensor. The microsystem has been tested to operate with an input cross-scale dynamic range of over 100dB and allows to resolve bidirectional redox currents with input-referred RMS noise of 46pA. The system features programmable current gain control, configurable anti-aliasing circuitry, triggered current integration and provides differential voltage-mode output ready for asynchronous external analog-to-digital conversion over a compressed dynamic range. The neurochemical interface has been demonstrated in real-time in vitro measurements of dopamine concentration.

REFERENCES


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